

Tentative

CM600DU-24NFH

Pre.	M.Koura	Rev	A	M. Koura
Apr.	Mtabata 21-Nov.'02			M. Tabata 9-Apr.'03

HIGH POWER SWITCHING USE

Notice : This is not a final specification. Some parametric limits are subject to change.

CM600DU-24NFH	
●I <sub>c</sub> .....	600A
●V <sub>CES</sub> .....	1200V
●Insulated Type	
●2-elements in a pack	

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APPLICATION

High frequency switching use (30kHz to 60kHz).  
 Gradient amplifier, Induction heating, power supply, etc.

ABSOLUTE MAXIMUM RATINGS (T<sub>j</sub> = 25 °C)

Symbol	Item	Conditions	Ratings	Units
V <sub>CES</sub>	Collector-emitter voltage	G-E Short	1200	V
V <sub>GES</sub>	Gate-emitter voltage	C-E Short	±20	V
I <sub>c</sub>	Collector current	T <sub>c</sub> = 25 °C	600	A
I <sub>CM</sub>		Pulse (2)	1200	
I <sub>E</sub> (1)	Emitter current	T <sub>c</sub> = 25 °C	600	A
I <sub>EM</sub> (1)		Pulse (2)	1200	
P <sub>c</sub> (3)	Maximum collector dissipation	T <sub>c</sub> = 25 °C	1550	W
P <sub>c</sub> (3)	Maximum collector dissipation	T <sub>c</sub> ' = 25 °C *4	3700	W
T <sub>j</sub>	Junction temperature		-40~+150	°C
T <sub>stg</sub>	Storage temperature		-40~+125	°C
Viso	Isolation voltage	Main terminal to base plate, AC 1 min.	2500	V
-	Torque strength	Main terminal M6	3.5 ~ 4.5	N·m
-	Torque strength	Mounting holes M6	3.5 ~ 4.5	N·m
-	Weight	Typical value	580	g

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**CM600DU-24NFH**  
 HIGH POWER SWITCHING USE
ELECTRICAL CHARACTERISTICS ( $T_j = 25^\circ\text{C}$ )

Symbol	Item	Conditions	Min.	Typ.	Max.	Units	
$I_{CES}$	Collector cutoff current	$V_{CE}=V_{CES}, V_{GE}=0V$	—	—	1	mA	
$V_{GE(th)}$	Gate-emitter threshold voltage	$I_C=60mA, V_{CE}=10V$	5	6	7	V	
$I_{GES}$	Gate leakage current	$V_{GE}=V_{GES}, V_{CE}=0V$	—	—	2.0	$\mu A$	
$V_{CE(sat)}$	Collector to emitter saturation voltage ④	$T_j = 25^\circ\text{C}$	—	5.0	6.5	V	A
		$T_j = 125^\circ\text{C}$					
$C_{ies}$	Input capacitance	$V_{CE}=10V$	—	—	95	nF	
$C_{oes}$	Output capacitance	$V_{GE}=0V$	—	—	8.0		
$C_{res}$	Reverse transfer capacitance		—	—	1.8		
$Q_G$	Total gate charge	$V_{CC}=600V, I_C=600A, V_{GE}=15V$	—	2700	—	nC	
$t_{d(on)}$	Turn-on delay time	$V_{CC}=600V, I_C=600A$	—	—	400	ns	A
$t_r$	Turn-on rise time	$V_{GE1}=V_{GE2}=15V$	—	—	120		
$t_{d(off)}$	Turn-off delay time	$R_G=0.52\Omega, \text{Inductive load}$	—	—	700		
$t_f$	Turn-off fall time	Switching operation	—	—	150		
$t_{rr}$ ①	Reverse recovery time	$I_E=600A$	—	—	250	ns	
$Q_{rr}$ ①	Reverse recovery charge		—	28	—	$\mu C$	A
$V_{EC}$ ①	Emitter-collector voltage	$I_E=600A, V_{GE}=0V$	—	—	3.5	V	A
$R_{th(j-c)Q}$	Thermal resistance	IGBT part (1/2 module)	—	—	0.083	$^\circ\text{C/W}$	A
$R_{th(j-c)R}$		FWDi part(1/2 module)	—	—	0.15		
$R_{th(c-f)}$	Contact thermal resistance	Case to fin, Thermal compound Applied (1/2module) *2	—	0.02	—		
$R_{th(j-c')Q}$	Thermal resistance *4	IGBT part (1/2 module)	—	—	0.034*3		
$R_{th(j-c')R}$		FWDi part(1/2 module)	—	—	0.06*3		
$R_G$	External gate resistance		0.52	—	5.2	$\Omega$	

\*1:  $T_c$  measured point is shown in page OUTLINE DRAWING.

\*2: Typical value is measured by using Shin-etsu Silicone "G-746".

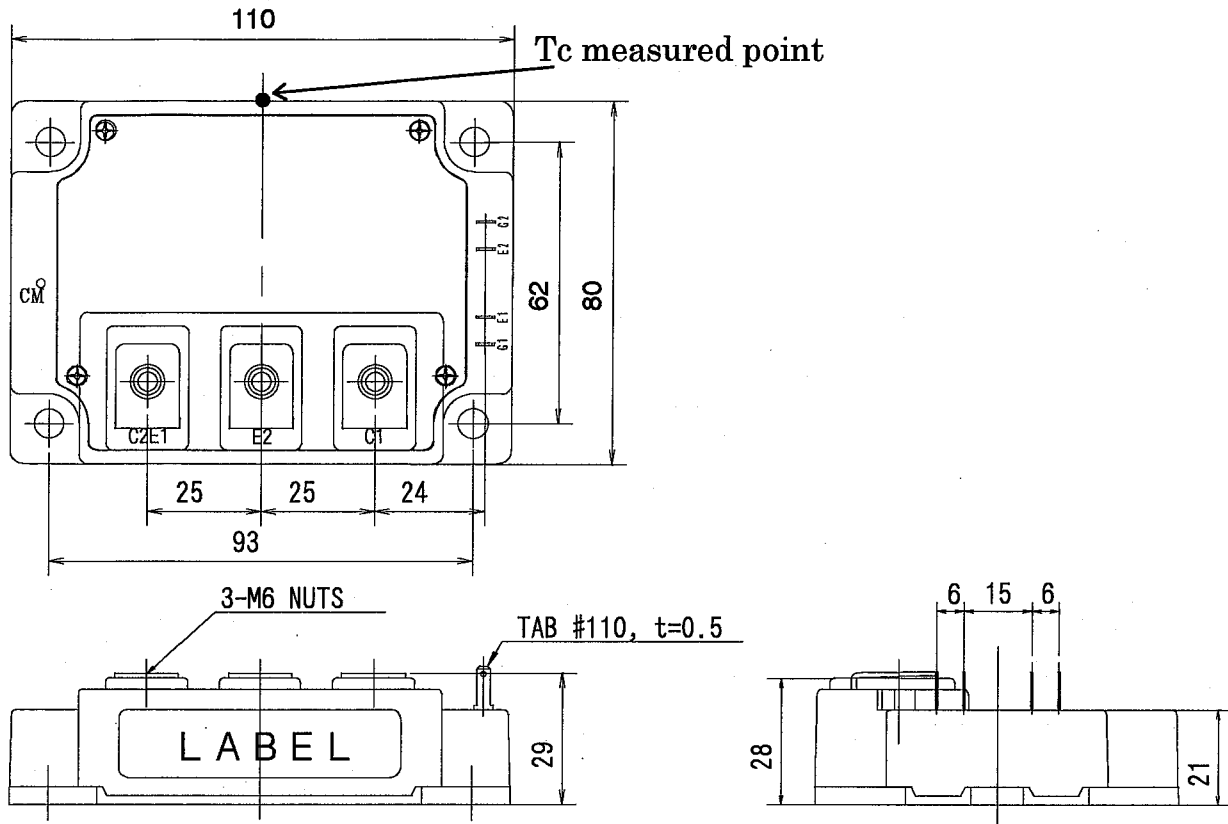
\*3: If you use this value,  $R_{th(f-a)}$  should be measured just under the chips.

\*4:  $T_c'$  measured point is just under the chips.

- ①  $I_E, V_{EC}, t_{rr}, Q_{rr}$  &  $di/dt$  represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWDi).
- ② Pulse width and repetition rate should be such that the device junction temp. ( $T_j$ ) dose not exceed  $T_{jmax}$  rating.
- ③ Junction temperature ( $T_j$ ) should not increase beyond  $150^\circ\text{C}$ .
- ④ Pulse width and repetition rate should be such as to cause negligble temperature rise.
- ⑤ No short circuit capability is designed.

OUTLINE DRAWING

Dimensions in mm



CIRCUIT DIAGRAM

